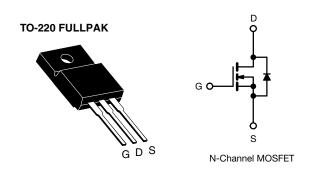
Vishay Siliconix

COMPLIANT

HALOGEN

FREE

E Series Power MOSFET



PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	650)		
R _{DS(on)} max. (Ω) at 25 °C	$V_{GS} = 10 \text{ V}$	0.158		
Q _g max. (nC)	95			
Q _{gs} (nC)	16	i		
Q _{gd} (nC)	25			
Configuration	Sing	le		

FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Qa)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-220 FULLPAK
Lead (Pb)-free and Halogen-free	SiHF23N60E-GE3

PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage			V _{DS}	600	V
Gate-Source Voltage			V_{GS}	± 30	v
Continuous Drain Current (T,I = 150 °C) e	V _{GS} at 10 V	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$		23	
Continuous Drain Current (1) = 150 C)	V _{GS} at 10 V	T _C = 100 °C	I _D	15	Α
Pulsed Drain Current ^a			I _{DM}	63	
Linear Derating Factor				0.28	W/°C
Single Pulse Avalanche Energy b			E _{AS}	353	mJ
Maximum Power Dissipation			P _D	35	W
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +150	°C
Drain-Source Voltage Slope T _J = 125 °C		d\//d+	37	V/ns	
Reverse Diode dV/dt ^d			dV/dt		
Soldering Recommendations (Peak temperature) c For 10 s		10 s		300	°C
Mounting Torque M3 screw			0.6	Nm	

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 5 A.
- c. 1.6 mm from case.
- d. $I_{SD} \le I_D$, dI/dt = 100 A/ μ s, starting $T_J = 25$ °C.
- e. Limited by maximum junction temperature.



Vishay Siliconix

THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R _{thJA}	=	65	°C/W
Maximum Junction-to-Case (Drain)	R_{thJC}	-	3.6	C/VV

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static				l	•	•	
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} :	= 0 V, I _D = 250 μA	600	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I _D = 1 mA	-	0.72	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μA	2	-	4	V
Cata Carriaga Lagliaga			V _{GS} = ± 20 V	-	-	± 100	nA
Gate-Source Leakage	I _{GSS}		V _{GS} = ± 30 V	-	-	± 1	μΑ
Zava Cata Valtaga Drain Current		V _{DS} =	= 600 V, V _{GS} = 0 V	-	-	1	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 480 \	/, V _{GS} = 0 V, T _J = 125 °C	-	-	10	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 12 A	-	0.132	0.158	Ω
Forward Transconductance	9 _{fs}	V_{DS}	= 30 V, I _D = 12 A	-	6.4	-	S
Dynamic							
Input Capacitance	C _{iss}	V _{GS} = 0 V,			2418	-	
Output Capacitance	C _{oss}		$V_{\rm GS} = 0 \text{ V},$ $V_{\rm DS} = 100 \text{ V},$		119	-	pF
Reverse Transfer Capacitance	C _{rss}	f = 1 MHz		-	4	-	
Effective Output Capacitance, Energy Related ^a	C _{o(er)}	V 0V 400V V 0V		-	107	-	
Effective Output Capacitance, Time Related ^b	C _{o(tr)}	V _{DS} = 0 \	/ to 480 V, V _{GS} = 0 V	-	320	-	
Total Gate Charge	Qg			-	63	95	
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	$I_D = 12 A, V_{DS} = 480 V$	-	16	-	nC
Gate-Drain Charge	Q _{gd}			-	25	-	
Turn-On Delay Time	t _{d(on)}			-	22	44	
Rise Time	t _r	V _{DD} =	= 480 V, I _D = 12 A,	-	38	76	
Turn-Off Delay Time	t _{d(off)}	V _{GS} :	$V_{GS} = 10 \text{ V}, R_g = 9.1 \Omega$		66	99	ns
Fall Time	t _f			-	34	68	
Gate Input Resistance	R _g	f = 1 MHz, open drain		-	0.73	-	Ω
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET sym showing the	MOSFET symbol showing the		-	23	_
Pulsed Diode Forward Current	I _{SM}	integral revers p - n junction	₹ }	-	-	63	- A
Diode Forward Voltage	V _{SD}	T _J = 25 °C	C, I _S = 12 A, V _{GS} = 0 V	-	0.9	1.2	V
Reverse Recovery Time	t _{rr}			-	384	768	ns
Reverse Recovery Charge	Q _{rr}		5 °C, I _F = I _S = 12 A,	-	6.4	12.8	μC
Reverse Recovery Current	I _{RRM}	ai/at =	100 A/ μ s, V _R = 25 V	_	30	-	A

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

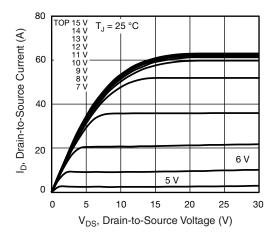


Fig. 1 - Typical Output Characteristics

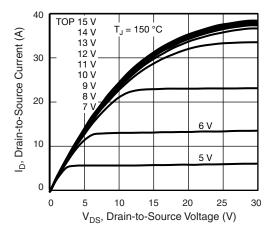


Fig. 2 - Typical Output Characteristics

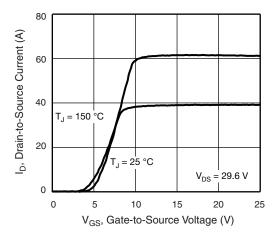


Fig. 3 - Typical Transfer Characteristics

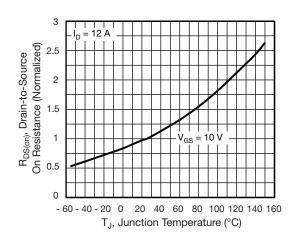


Fig. 4 - Normalized On-Resistance vs. Temperature

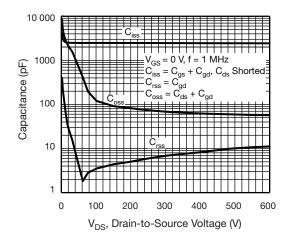


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

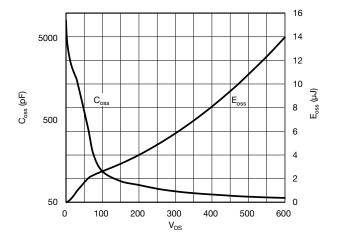


Fig. 6 - Coss and Eoss vs. VDS



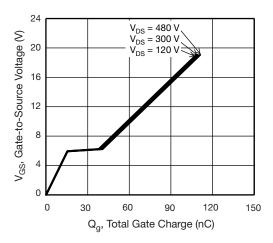


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

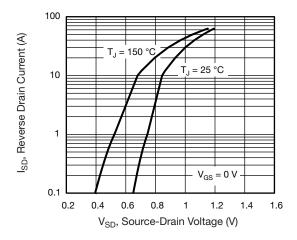


Fig. 8 - Typical Source-Drain Diode Forward Voltage

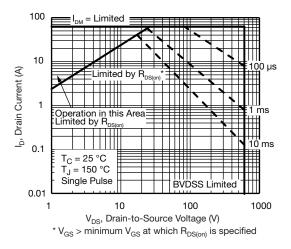


Fig. 9 - Maximum Safe Operating Area

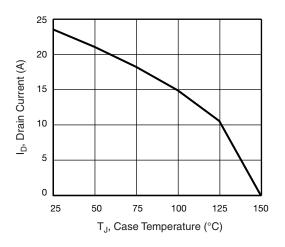


Fig. 10 - Maximum Drain Current vs. Case Temperature

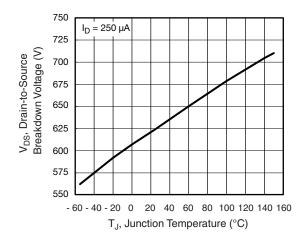


Fig. 11 - Temperature vs. Drain-to-Source Voltage



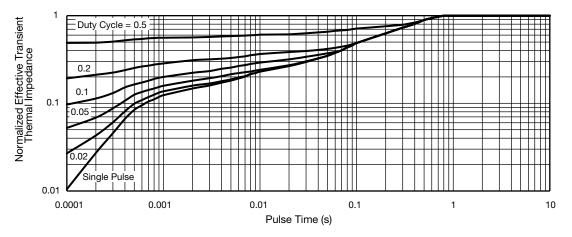


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

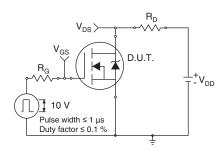


Fig. 13 - Switching Time Test Circuit

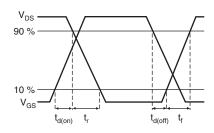


Fig. 14 - Switching Time Waveforms

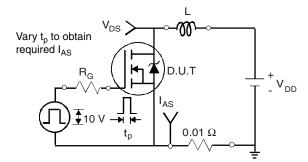


Fig. 15 - Unclamped Inductive Test Circuit

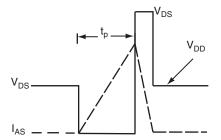


Fig. 16 - Unclamped Inductive Waveforms

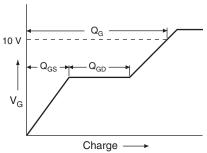


Fig. 17 - Basic Gate Charge Waveform

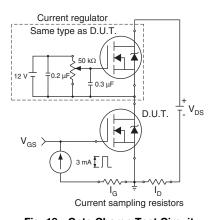
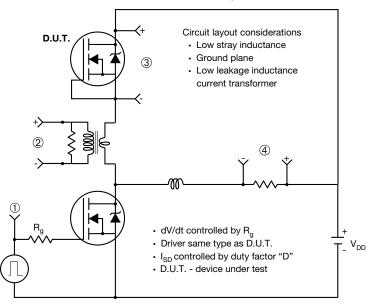


Fig. 18 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



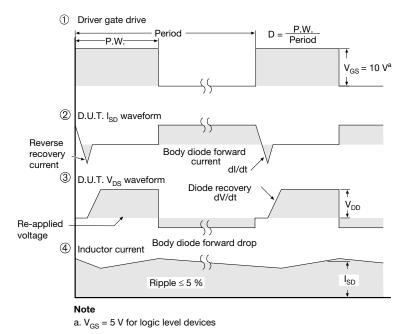


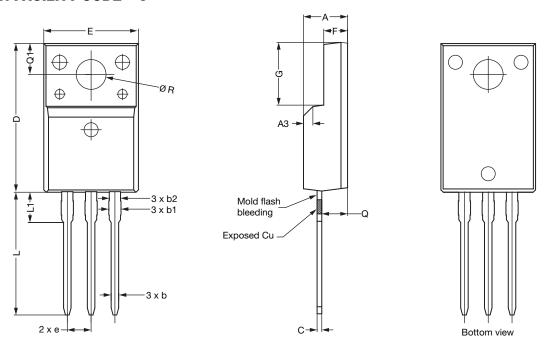
Fig. 19 - For N-Channel

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Vishay Siliconix

TO-220 FULLPAK (High Voltage)

OPTION 1: FACILITY CODE = 9

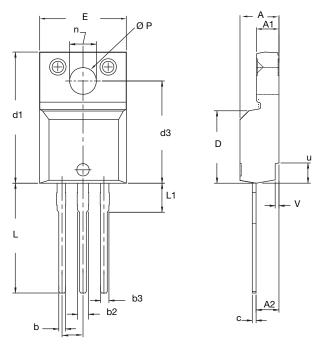


		MILLIMETERS	
DIM.	MIN.	NOM.	MAX.
Α	4.60	4.70	4.80
b	0.70	0.80	0.91
b1	1.20	1.30	1.47
b2	1.10	1.20	1.30
С	0.45	0.50	0.63
D	15.80	15.87	15.97
е		2.54 BSC	
E	10.00	10.10	10.30
F	2.44	2.54	2.64
G	6.50	6.70	6.90
L	12.90	13.10	13.30
L1	3.13	3.23	3.33
Q	2.65	2.75	2.85
Q1	3.20	3.30	3.40
ØR	3.08	3.18	3.28

- 1. To be used only for process drawing
- 2. These dimensions apply to all TO-220 FULLPAK leadframe versions 3 leads
- 3. All critical dimensions should C meet $C_{pk} > 1.33$
- 4. All dimensions include burrs and plating thickness
- 5. No chipping or package damage
- 6. Facility code will be the 1st character located at the 2nd row of the unit marking



OPTION 2: FACILITY CODE = Y



	MILLIM	IETERS	INCHES	
DIM.	MIN.	MAX.	MIN.	MAX.
Α	4.570	4.830	0.180	0.190
A1	2.570	2.830	0.101	0.111
A2	2.510	2.850	0.099	0.112
b	0.622	0.890	0.024	0.035
b2	1.229	1.400	0.048	0.055
b3	1.229	1.400	0.048	0.055
С	0.440	0.629	0.017	0.025
D	8.650	9.800	0.341	0.386
d1	15.88	16.120	0.622	0.635
d3	12.300	12.920	0.484	0.509
Е	10.360	10.630	0.408	0.419
е	2.54	BSC	0.100 BSC	
L	13.200	13.730	0.520	0.541
L1	3.100	3.500	0.122	0.138
n	6.050	6.150	0.238	0.242
ØΡ	3.050	3.450	0.120	0.136
u	2.400	2.500	0.094	0.098
V	0.400	0.500	0.016	0.020

ECN: E19-0180-Rev. D, 08-Apr-2019 DWG: 5972

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- 2. These dimensions apply to all TO-220 FULLPAK leadframe versions 3 leads
- 3. All critical dimensions should C meet $C_{pk} > 1.33$
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- 5. No chipping or package damage
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Vishay

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